

2SK1303 Silicon N Channel MOS FET

REJ03G0922-0200 (Previous: ADE-208-1261) Rev.2.00 Sep 07, 2005

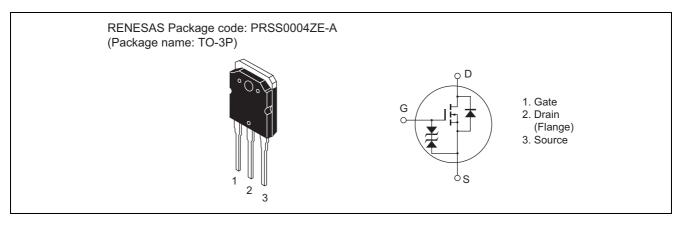
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device
- Can be driven from 5 V source
- Suitable for motor drive, DC-DC converter, power switch and solenoid drive

Outline





Absolute Maximum Ratings

(1a - 25 C)	(Ta	=	25°	C)
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Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	100	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	30	А
Drain peak current	I _{D(pulse)} *1	120	А
Body to drain diode reverse drain current	I _{DR}	30	А
Channel dissipation	Pch ^{*2}	100	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at $T_C = 25^{\circ}C$

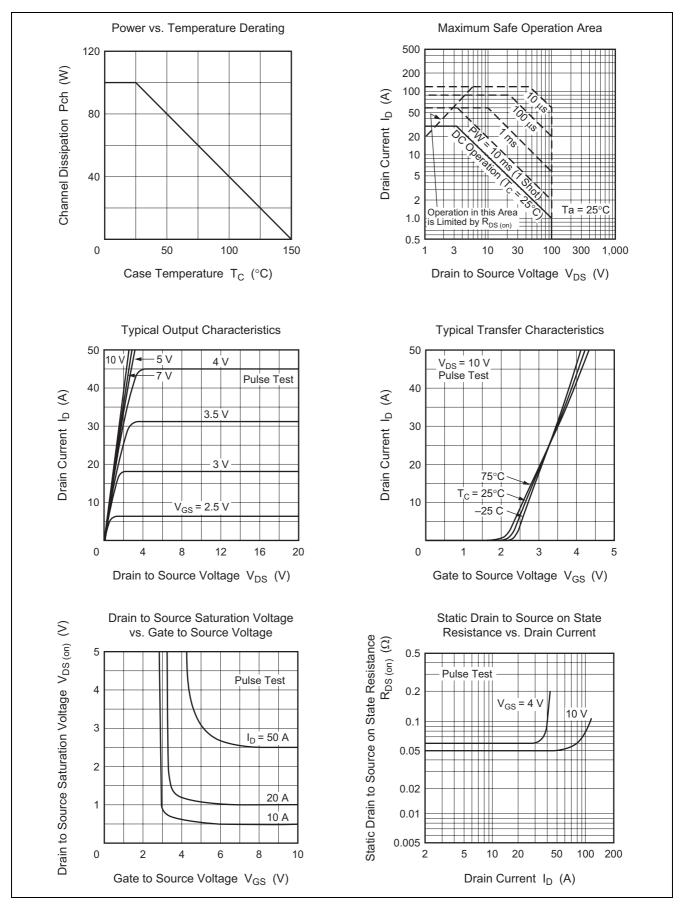
Electrical Characteristics

						(Ta = 25°C)
ltem	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	V _{(BR)DSS}	100	—	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	±20	—	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 16 V, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	—	250	μA	$V_{DS} = 80 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	1.0	_	2.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state	R _{DS(on)}	_	0.05	0.06	Ω	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{*3}$
resistance		_	0.06	0.09	Ω	$I_D = 15 \text{ A}, V_{GS} = 4 \text{ V}^{*3}$
Forward transfer admittance	y _{fs}	13	22	_	S	$I_D = 15 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$
Input capacitance	Ciss		1750	_	pF	$V_{DS} = 10 V, V_{GS} = 0,$
Output capacitance	Coss		710	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss		180	_	pF	
Turn-on delay time	t _{d(on)}		15	_	ns	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time	tr	_	120	_	ns	$R_L = 2 \Omega$
Turn-off delay time	t _{d(off)}	_	390	_	ns	
Fall time	t _f	_	195	_	ns	
Body to drain diode forward voltage	V_{DF}	_	1.3	_	V	$I_F = 30 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery	t _{rr}	_	360	_	ns	$I_F = 30 \text{ A}, V_{GS} = 0,$
time						di _F /dt = 50 A/µs

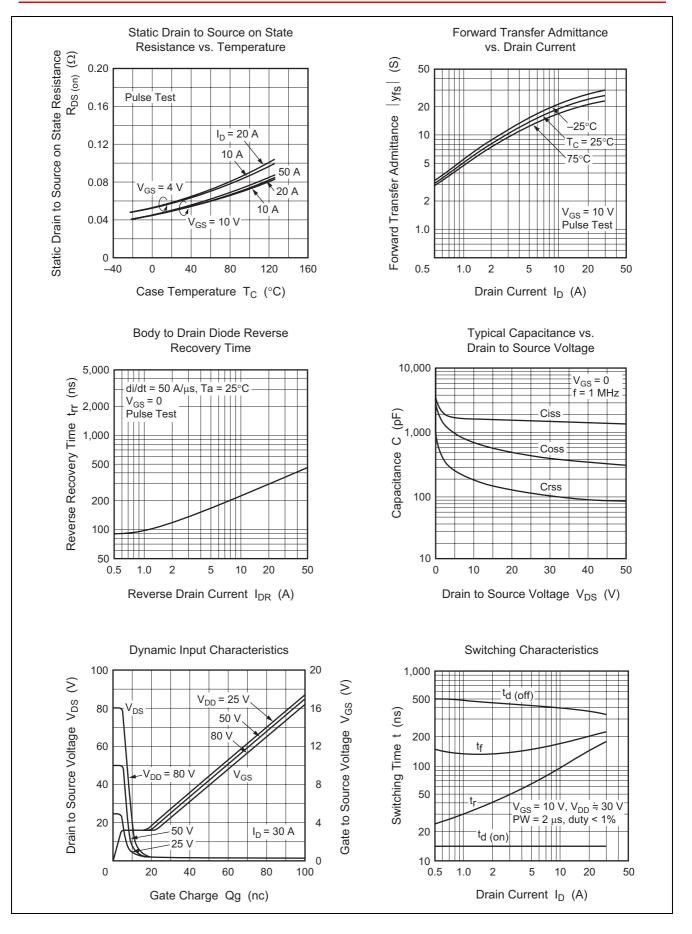
Note: 3. Pulse test



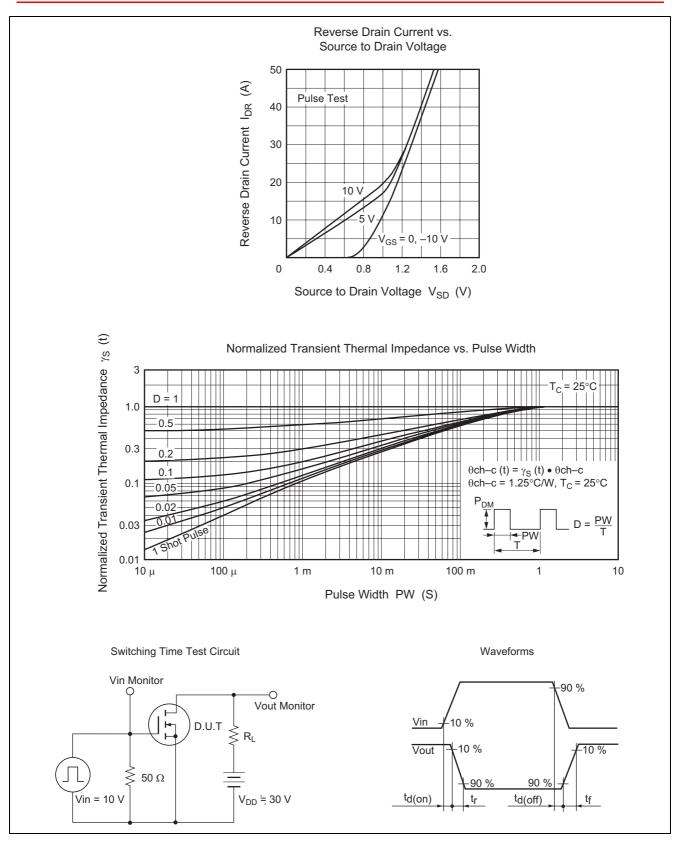
Main Characteristics





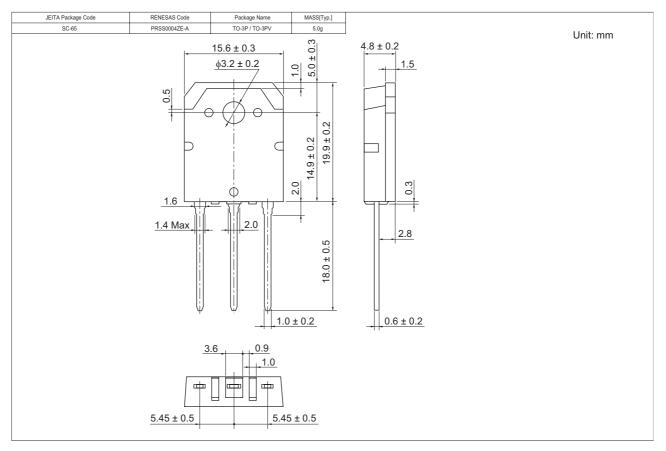






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Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SK1303-E	30 pcs	Plastic magazine

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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